HEF4053B

Triple single-pole double-throw analog switch Rev. 11 — 11 September 2014

Product data sheet

1. **General description**

The HEF4053B is a triple single-pole double-throw (SPDT) analog switch, suitable for use as an analog or digital multiplexer/demultiplexer. Each switch has a digital select input (Sn), two independent inputs/outputs (nY0 and nY1) and a common input/output (nZ). All three switches share an enable input (\overline{E}) . A HIGH on \overline{E} causes all switches into the high-impedance OFF-state, independent of Sn.

V_{DD} and V_{SS} are the supply voltage connections for the digital control inputs (Sn and E). The V_{DD} to V_{SS} range is 3 V to 15 V. The analog inputs/outputs (nY0, nY1 and nZ) can swing between V_{DD} as a positive limit and V_{EE} as a negative limit. $V_{DD} - V_{EE}$ may not exceed 15 V. Unused inputs must be connected to V_{DD}, V_{SS}, or another input. For operation as a digital multiplexer/demultiplexer, V_{EE} is connected to V_{SS} (typically ground). V_{EE} and V_{SS} are the supply voltage connections for the switches.

Features and benefits 2.

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from –40 °C to +125 °C
- Complies with JEDEC standard JESD 13-B

3. **Applications**

- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating

Ordering information

Table 1. **Ordering information**

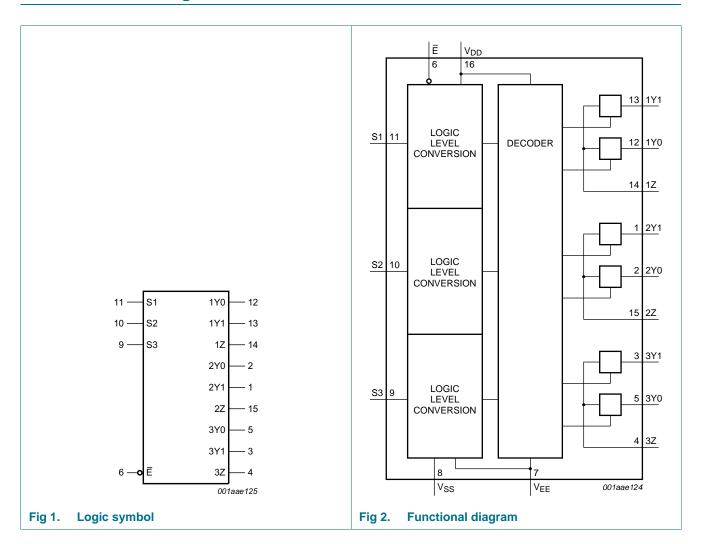
All types operate from $-40 \,^{\circ}\text{C}$ to $+125 \,^{\circ}\text{C}$.

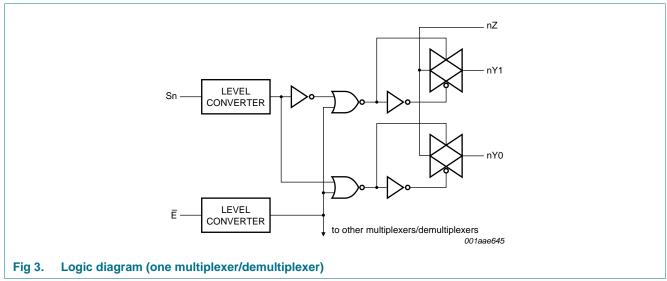
Type number	Package								
Name		Description	Version						
HEF4053BP	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4						
HEF4053BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1						
HEF4053BTT	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1						



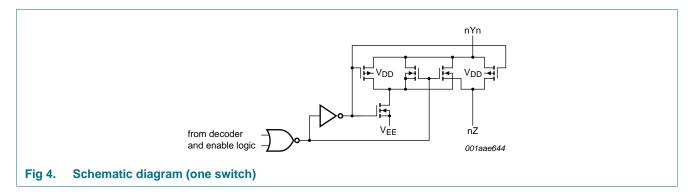
Triple single-pole double-throw analog switch

5. Functional diagram



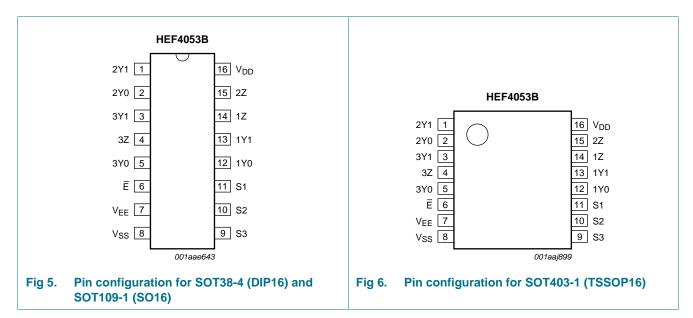


Triple single-pole double-throw analog switch



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
Ē	6	enable input (active LOW)
V _{EE}	7	supply voltage
V _{SS}	8	ground supply voltage
S1, S2, S3	11, 10, 9	select input
1Y0, 2Y0, 3Y0	12, 2, 5	independent input or output
1Y1, 2Y1, 3Y1	13, 1, 3	independent input or output
1Z, 2Z, 3Z	14, 15, 4	independent output or input
V_{DD}	16	supply voltage

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7. Functional description

Table 3. Function table [1]

Inputs	Channel on	
Ē	Sn	
L	L	nY0 to nZ
L	Н	nY1 to nZ
Н	X	switches OFF

^[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to V_{SS} = 0 V (ground).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{DD}	supply voltage			-0.5	+18	V
V _{EE}	supply voltage	referenced to V _{DD}	[1]	-18	+0.5	V
I _{IK}	input clamping current	pins Sn and \overline{E} ; V _I < -0.5 V or V _I > V _{DD} + 0.5 V		-	±10	mA
VI	input voltage			-0.5	V _{DD} + 0.5	V
I _{I/O}	input/output current			-	±10	mA
I _{DD}	supply current			-	50	mA
T _{stg}	storage temperature			-65	+150	°C
T _{amb}	ambient temperature			-40	+125	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	[2]			
		DIP16 package		-	750	mW
		SO16 package		-	500	mW
		TSSOP16 package		-	500	mW
Р	power dissipation	per output		-	100	mW

^[1] To avoid drawing V_{DD} current out of terminal Z, when switch current flows into terminals Y, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no V_{DD} current will flow out of terminals Y, and in this case there is no limit for the voltage drop across the switch, but the voltages at Y and Z may not exceed V_{DD} or V_{EE}.

9. Recommended operating conditions

Table 5. Recommended operating conditions

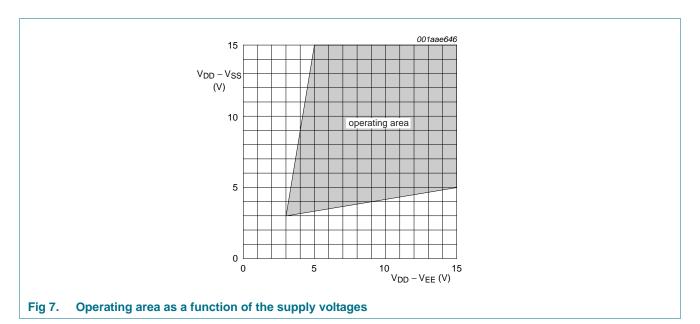
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{DD}	supply voltage	see Figure 7	3	-	15	V
VI	input voltage		0	-	V_{DD}	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C

^[2] For DIP16 package: P_{tot} derates linearly with 12 mW/K above 70 °C. For SO16 package: P_{tot} derates linearly with 8 mW/K above 70 °C. For TSSOP16 package: P_{tot} derates linearly with 5.5 mW/K above 60 °C.

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 Table 5.
 Recommended operating conditions ...continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Δt/ΔV	input transition rise and fall	$V_{DD} = 5 V$	-	-	3.75	μs/V
	rate	V _{DD} = 10 V	-	-	0.5	μs/V
		V _{DD} = 15 V	-	-	0.08	μs/V



10. Static characteristics

Table 6. Static characteristics

 $V_{SS} = V_{EE} = 0 \ V$; $V_I = V_{SS}$ or V_{DD} unless otherwise specified.

Symbol	Parameter	Conditions	V_{DD}	T _{amb} =	–40 °C	T _{amb} =	25 °C	T _{amb} =	85 °C	T _{amb} =	125 °C	Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
V_{IH}	HIGH-level	I _O < 1 μA	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V
	input voltage	out voltage	10 V	7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	11.0	-	V
V_{IL}	LOW-level	I _O < 1 μA	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
	input voltage		10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
l _l	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	-	±1.0	μΑ
I _{S(OFF)}	OFF-state leakage current	Z port; all channels OFF; see <u>Figure 8</u>	15 V	-	-	-	1000	-	-	-	-	nA
		Y port; per channel; see Figure 9	15 V	-	-	-	200	-	-	-	-	nA

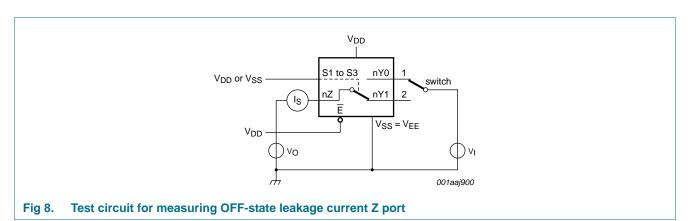
Triple single-pole double-throw analog switch

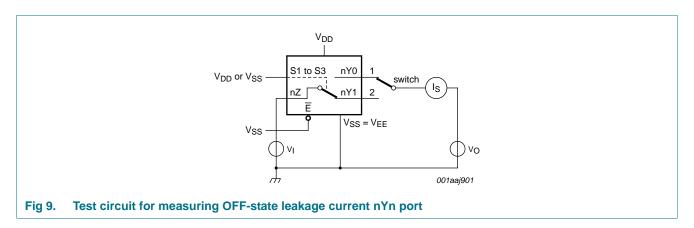
 Table 6.
 Static characteristics ...continued

 $V_{SS} = V_{EE} = 0 \text{ V}; V_I = V_{SS} \text{ or } V_{DD} \text{ unless otherwise specified.}$

Symbol	Parameter	Conditions	V_{DD}	T _{amb} =	–40 °C	T _{amb} =	25 °C	T _{amb} =	85 °C	T _{amb} =	125 °C	Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
I_{DD}	supply current	I _O = 0 A	5 V	-	5	-	5	-	150	-	150	μΑ
			10 V	-	10	-	10	-	300	-	300	μΑ
			15 V	-	20	-	20	-	600	-	600	μΑ
Cı	input capacitance	Sn, E inputs	-	-	-	-	7.5	-	-	-	-	pF

10.1 Test circuits





10.2 ON resistance

Table 7. ON resistance

 $T_{amb} = 25$ °C; $I_{SW} = 200~\mu A$; $V_{SS} = V_{EE} = 0~V$.

Symbol	Parameter	Conditions	$V_{DD} - V_{EE}$	Тур	Max	Unit
R _{ON(peak)}	ON resistance (peak)	$V_I = 0 V \text{ to } V_{DD} - V_{EE};$	5 V	350	2500	Ω
		see Figure 10 and Figure 11	10 V	80	245	Ω
			15 V	60	175	Ω

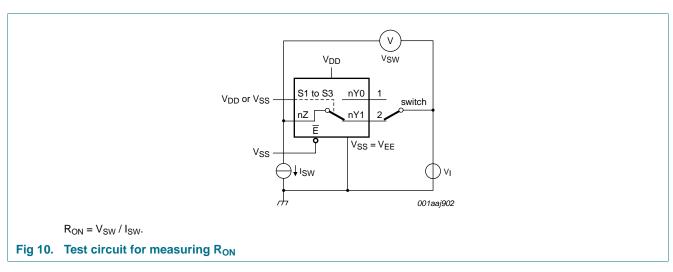
Triple single-pole double-throw analog switch

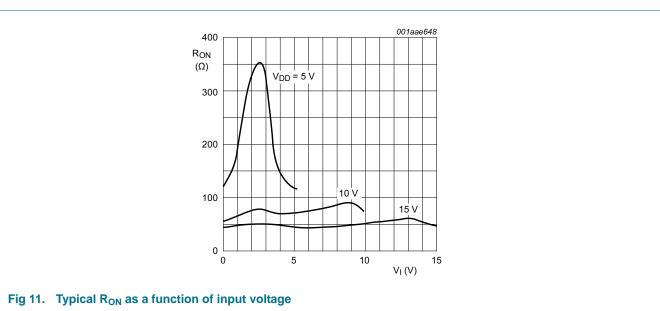
 Table 7.
 ON resistance ...continued

 $T_{amb} = 25$ °C; $I_{SW} = 200 \mu A$; $V_{SS} = V_{EE} = 0 \text{ V}$.

Symbol	Parameter	Conditions	$V_{DD} - V_{EE}$	Тур	Max	Unit
R _{ON(rail)}	ON resistance (rail)	V _I = 0 V; see <u>Figure 10</u> and <u>Figure 11</u>	5 V	115	340	Ω
			10 V	50	160	Ω
			15 V	40	115	Ω
		$V_I = V_{DD} - V_{EE};$	5 V	120	365	Ω
		see Figure 10 and Figure 11	10 V	65	200	Ω
			15 V	50	155	Ω
ΔR_{ON}	ON resistance mismatch	$V_I = 0 \text{ V to } V_{DD} - V_{EE}$; see <u>Figure 10</u>	5 V	25	-	Ω
	between channels		10 V	10	-	Ω
			15 V	5	-	Ω

10.2.1 ON resistance waveform and test circuit





Triple single-pole double-throw analog switch

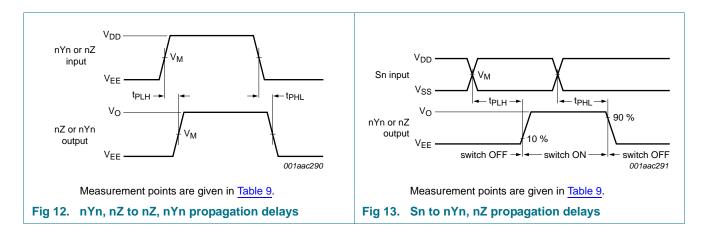
11. Dynamic characteristics

Table 8. Dynamic characteristics

 $T_{amb} = 25$ °C; $V_{SS} = V_{EE} = 0$ V; for test circuit see <u>Figure 15</u>.

Symbol	Parameter	Conditions	V_{DD}	Тур	Max	Unit
t _{PHL}	HIGH to LOW propagation delay	nYn, nZ to nZ, nYn; see Figure 12	5 V	10	20	ns
			10 V	5	10	ns
			15 V	5	10	ns
		Sn to nYn, nZ; see Figure 13	5 V	200	400	ns
			10 V	85	170	ns
			15 V	65	130	ns
t _{PLH} LO'	LOW to HIGH propagation delay	nYn, nZ to nZ, nYn; see Figure 12	5 V	15	30	ns
			10 V	5	10	ns
			15 V	5	10	ns
		Sn to nYn, nZ; see Figure 13	5 V	275	555	ns
			10 V	100	200	ns
			15 V	65	130	ns
t _{PHZ}	HIGH to OFF-state	E to nYn, nZ; see Figure 14	5 V	200	400	ns
	propagation delay		10 V	115	230	ns
			15 V	110	220	ns
t _{PZH}	OFF-state to HIGH	E to nYn, nZ; see Figure 14	5 V	260	525	ns
	propagation delay		10 V	95	190	ns
			15 V	65	130	ns
t _{PLZ}	LOW to OFF-state	E to nYn, nZ; see Figure 14	5 V	200	400	ns
	propagation delay		10 V	120	245	ns
			15 V	110	215	ns
t _{PZL}	OFF-state to LOW	E to nYn, nZ; see Figure 14	5 V	280	565	ns
-1 <u>-</u> L	propagation delay		10 V	105	205	ns
			15 V	70	140	ns

11.1 Waveforms and test circuit



Triple single-pole double-throw analog switch

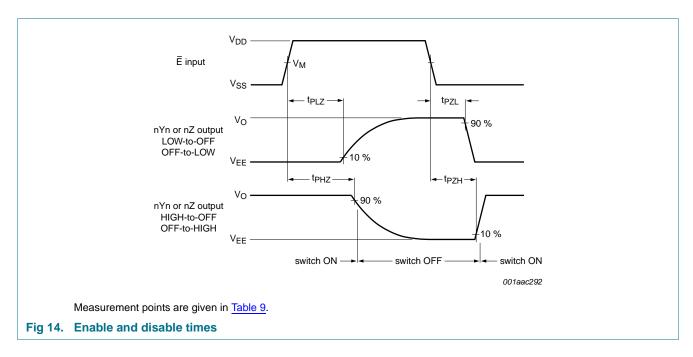


Table 9. Measurement points

Supply voltage	Input	Output		
V_{DD}	V _M	V _M		
5 V to 15 V	0.5V _{DD}	0.5V _{DD}		

Triple single-pole double-throw analog switch

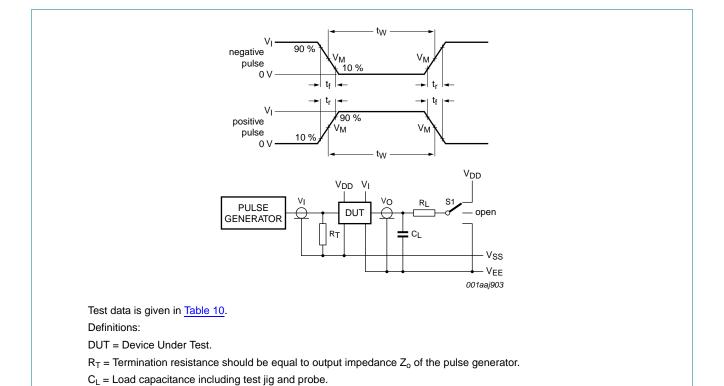


Fig 15. Test circuit for measuring switching times

R_L = Load resistance.

Table 10. Test data

Input				Load	Load S1 position					
nYn, nZ	Sn and E	t _r , t _f	V _M	CL	R_L	t _{PHL} [1]	t _{PLH}	t _{PZH} , t _{PHZ}	t_{PZL}, t_{PLZ}	other
V_{DD} or V_{EE}	V_{DD} or V_{SS}	≤ 20 ns	0.5V _{DD}	50 pF	10 kΩ	V_{DD} or V_{EE}	V _{EE}	V _{EE}	V_{DD}	V _{EE}

[1] For nYn to nZ or nZ to nYn propagation delays use V_{EE} . For Sn to nYn or nZ propagation delays use V_{DD} .

Triple single-pole double-throw analog switch

11.2 Additional dynamic parameters

Table 11. Additional dynamic characteristics

 $V_{SS} = V_{EE} = 0$ V; $T_{amb} = 25$ °C.

Symbol	Parameter	Conditions	V_{DD}		Тур	Max	Unit
THD	total harmonic distortion	see Figure 16; $R_L = 10 \text{ k}\Omega$; $C_L = 15 \text{ pF}$;	5 V	[1]	0.25	-	%
		channel ON; $V_I = 0.5V_{DD}$ (p-p); $f_i = 1 \text{ kHz}$	10 V	[1]	0.04	-	%
		II = I KIIZ	15 V	[1]	0.04	-	%
f _(-3dB)	-3 dB frequency response	see Figure 17; $R_L = 1 \text{ k}\Omega$; $C_L = 5 \text{ pF}$;	5 V	[1]	13	-	MHz
		channel ON; $V_I = 0.5V_{DD}$ (p-p)	10 V	[1]	40	-	MHz
			15 V	[1]	70	-	MHz
α_{iso}	isolation (OFF-state)	see Figure 18; f_i = 1 MHz; R_L = 1 k Ω ; C_L = 5 pF; channel OFF; V_I = 0.5 V_{DD} (p-p)	10 V	[1]	-50	-	dB
V _{ct}	crosstalk voltage	digital inputs to switch; see Figure 19; $\underline{R}_L = 10 \text{ k}\Omega$; $C_L = 15 \text{ pF}$; \overline{E} or $Sn = V_{DD}$ (square-wave)	10 V		50	-	mV
Xtalk	crosstalk	between switches; see Figure 20; $f_i = 1$ MHz; $R_L = 1$ k Ω ; $V_I = 0.5V_{DD}$ (p-p)	10 V	[1]	-50	-	dB

^[1] f_i is biased at 0.5 V_{DD} ; $V_I = 0.5 V_{DD}$ (p-p).

Table 12. Dynamic power dissipation P_D

 P_D can be calculated from the formulas shown; $V_{EE} = V_{SS} = 0$ V; $t_r = t_f \le 20$ ns; $T_{amb} = 25$ °C.

			, 22 00 , , , , amb	
Symbol	Parameter	V_{DD}	Typical formula for P _D (μW)	where:
P_D	dynamic power	5 V	$P_D = 2500 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	f _i = input frequency in MHz;
dissipation		10 V	$P_D = 11500 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	fo = output frequency in MHz;
		15 V	$P_D = 29000 \times f_i + \Sigma (f_0 \times C_L) \times V_{DD}^2$	C _L = output load capacitance in pF;
				V _{DD} = supply voltage in V;
				$\Sigma(C_L \times f_o)$ = sum of the outputs.

11.2.1 Test circuits

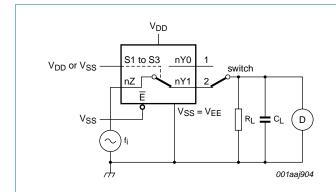


Fig 16. Test circuit for measuring total harmonic distortion

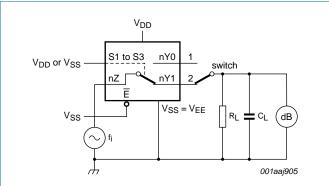
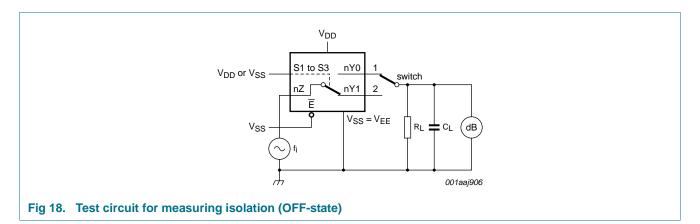
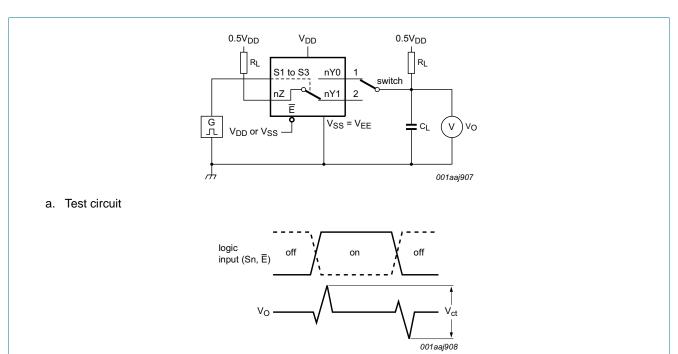


Fig 17. Test circuit for measuring frequency response

Triple single-pole double-throw analog switch

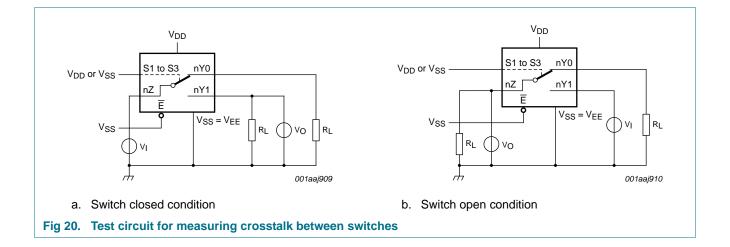




b. Input and output pulse definitions

Fig 19. Test circuit for measuring crosstalk voltage between digital inputs and switch

Triple single-pole double-throw analog switch

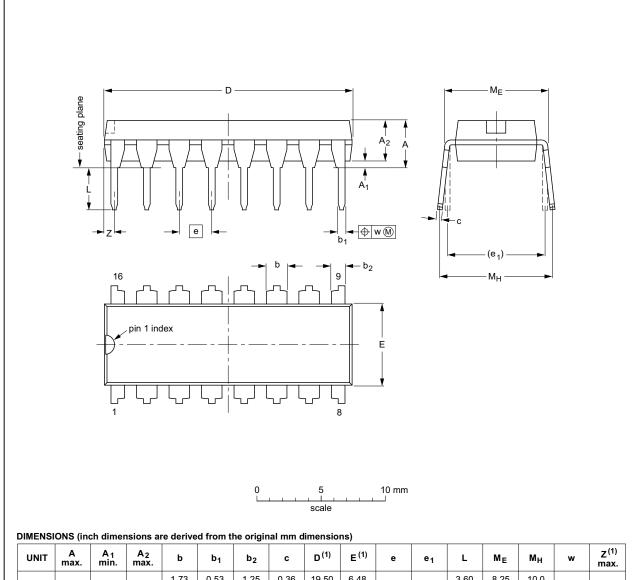


Triple single-pole double-throw analog switch

12. Package outline

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.02	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.1	0.3	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.03

Note

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

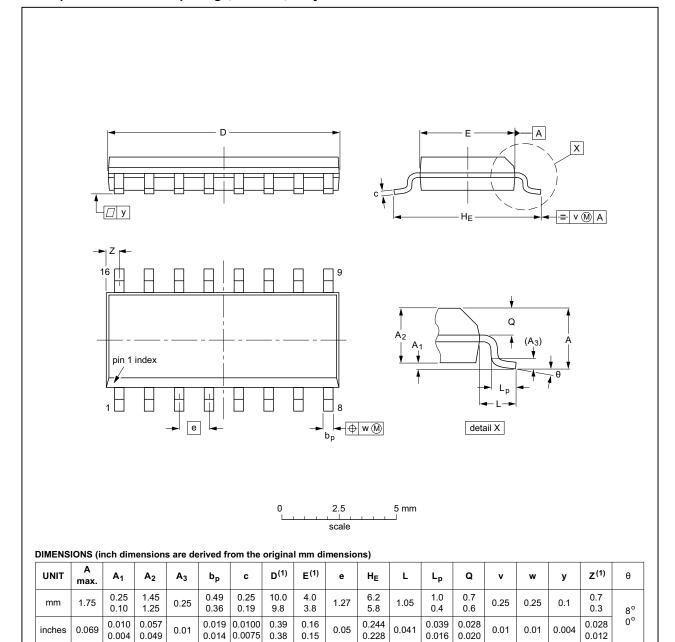
OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT38-4						95-01-14 03-02-13	

Fig 21. Package outline SOT38-4 (DIP16)

Triple single-pole double-throw analog switch

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT109-1	076E07	MS-012				99-12-27 03-02-19	

Fig 22. Package outline SOT109-1 (SO16)

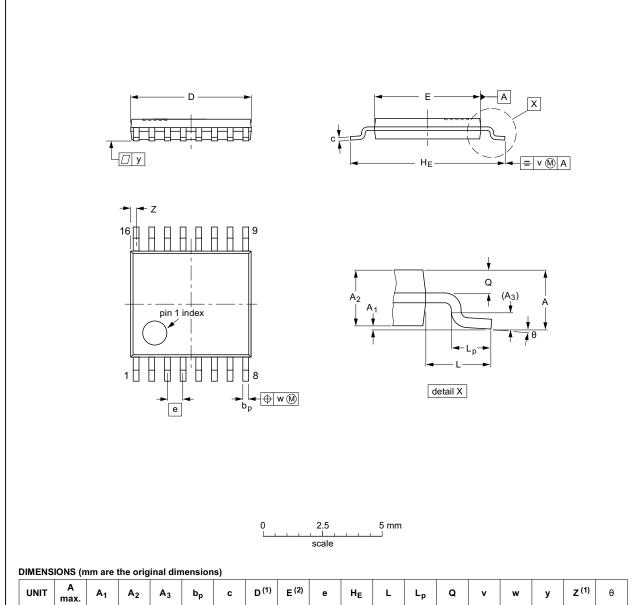
HEF4053B

Note

Triple single-pole double-throw analog switch

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E (2)	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

IEC JEDE	C JEIT		PROJECTION	ISSUE DATE	
	JEII	Α	PROJECTION	ISSUE DATE	
MO-1	53			-99-12-27 03-02-18	
	MO-18	MO-153	MO-153	MO-153	

Fig 23. Package outline SOT403-1 (TSSOP16)

Triple single-pole double-throw analog switch

13. Abbreviations

Table 13. Abbreviations

Acronym	Description
DUT	Device Under Test

14. Revision history

Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4053B v.11	20140911	Product data sheet	-	HEF4053B v.10
Modifications:	• <u>Figure 19</u> : 7	est circuit modified		
HEF4053B v.10	20111117	Product data sheet	-	HEF4053B v.9
Modifications:	Legal pages	s updated.	"	
	 Changes in 	"General description", "Feat	tures and benefits" and	"Applications".
HEF4053B v.9	20100325	Product data sheet	-	HEF4053B v.8
HEF4053B v.8	20100224	Product data sheet	-	HEF4053B v.7
HEF4053B v.7	20091127	Product data sheet	-	HEF4053B v.6
HEF4053B v.6	20090924	Product data sheet	-	HEF4053B v.5
HEF4053B v.5	20090825	Product data sheet	-	HEF4053B v.4
HEF4053B v.4	20090713	Product data sheet	-	HEF4053B_CNV v.3
HEF4053B_CNV v.3	19950101	Product specification	-	HEF4053B_CNV v.2
HEF4053B_CNV v.2	19950101	Product specification	-	-

Triple single-pole double-throw analog switch

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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